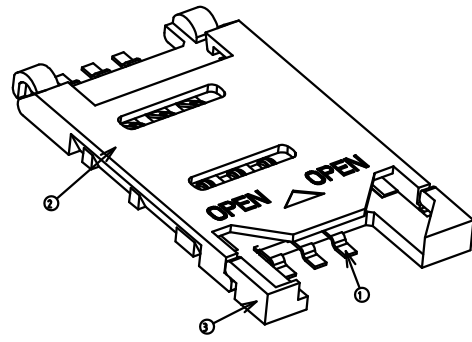
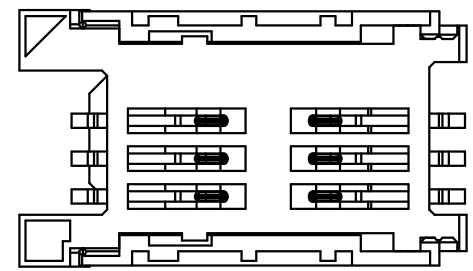
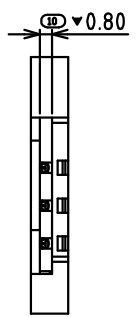
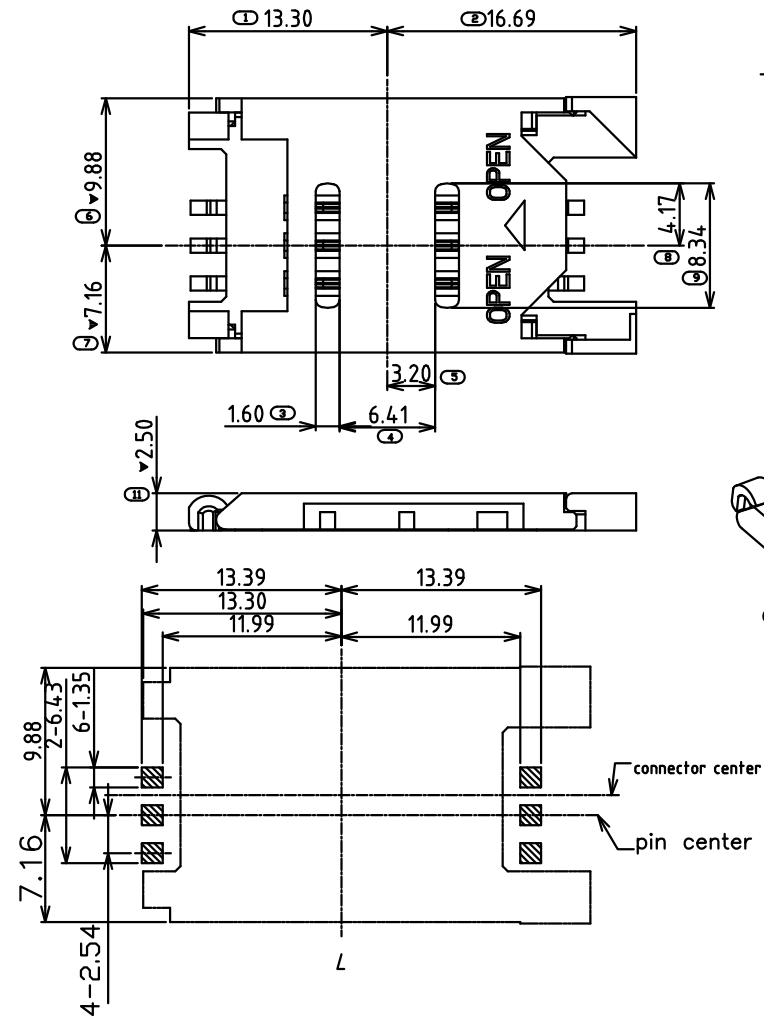


REV.	ECN.NO.	APPD.
A	/	/



- *Electrical Characteristics:
 Contact Current Rating:0.5 Amperes.
 Dielectric Withstanding Voltage:AC500V r.m.s.
 Insulation Resistance:1000 MΩ Minimum.
 Contact Resistance:100 mΩ Maximum.
- *Environmental:
 Operating Temperature:-25°C~+90°C.
- *Environmental:
 Mating Cycles:5000~10,000 Insertions.
- *Mechanical Characteristics:
 Card Push Insertion/Out Force:1.4kgf. MAX
 Contact Separation Force:0.20kgf Minimum.
- *Material:
 Insulator:HI-Temp Plastic UL 94V-0 Rated.
 Contact:Copper Alloy(t=0.15mm).
 Shell:Stainless Steel(t=0.20mm).
 Spring:SWP.

SD5209-021-G618

G. 半金G/FU" 1. 黑色
 6. LCP

TOLERANCE UNLESS OTHERWISE SPECIFIED		FLW 深圳市华联威电子科技有限公司 HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.				
.XXX ±0.10	.XX ±0.20	.X ±0.30	.X' ±3'	.XX' ±2'		
APPROVED		PART NAME:	2.5H 全塑型掀盖SMT卡			
CHECKED		PART No:	SD5209-021-G618	C		
DRAWN	weihong	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2021.7.23		mm	1:1	10F1	A